

Title (en)

COBALT SILICIDE-CONTAINING COPPER ALLOY

Title (de)

KOBALTSILIZIDHALTIGE KUPFERLEGIERUNG

Title (fr)

ALLIAGE DE CUIVRE CONTENANT DU SILICIURE DE COBALT

Publication

EP 3363922 A4 20190821 (EN)

Application

EP 16826980 A 20160608

Priority

- CN 201510439092 A 20150723
- CN 2016000301 W 20160608

Abstract (en)

[origin: US2018066339A1] The present invention discloses copper alloy containing cobalt and silicon, which comprises (in percentage of weight): 69% to 92% of copper; 6.5% to 30.5% of zinc; 0.01% to 3% of cobalt; and 0.01% to 0.5% of silicon; wherein the total content of copper and zinc is greater than 95%, and the content of inevitable impurities is less than 0.2%. Preferably, the copper alloy comprises matrix phases of copper-zinc a solid solution and CoxSiy precipitated phases; the CoxSiy precipitated phases are dispersedly distributed on a matrix phase; the percentage of the matrix phases by area is greater than or equal to 95%; and, the percentage of the CoxSiy precipitated phases by area is 0.01% to 5%.

IPC 8 full level

C22C 9/04 (2006.01); **C22F 1/08** (2006.01)

CPC (source: EP US)

C22C 9/04 (2013.01 - EP US); **C22F 1/08** (2013.01 - EP US)

Citation (search report)

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Designated contracting state (EPC)

AL AT BE BG CH CY CZ DE DK EE ES FI FR GB GR HR HU IE IS IT LI LT LU LV MC MK MT NL NO PL PT RO RS SE SI SK SM TR

DOCDB simple family (publication)

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